

TFT COLOR LCD MODULE

Type: NL10276AC30-07 38 cm (15.0 Type), XGA

Ultra Wide Viewing Angle (H/V 170° (typ)) high luminance (400 cd/m² typ.) Parallel 8bit Interface (2 port)

SPECIFICATIONS

(4th Edition)

PRELIMINARY

This document is preliminary. All information in this document are subject to change without prior notice

NEC Corporation NEC Electron Devices Display Device Operatio Color LCD Division 1st Engineering Departm	
Approved	June 12, 2001
Checked	

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Prepared

June 12,

2001

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1. OUTLINE

1.1 STRUCTURE AND PRINCIPLE

NL10276AC30-07 module is composed of the driver LSIs for driving the TFT (Thin Film Transistor) array with an amorphous silicon thin film transistor liquid crystal display (a-Si TFT LCD) panel structure and a backlight.

The a-Si TFT LCD panel structure is injected liquid crystal material into the narrow gap between a TFT array glass substrate and a color filter glass substrate.

RGB (Red, Green, Blue) data signals from a source system are modulated into a form suitable for active matrix addressing by the onboard signal processor and sent to the driver LSIs which in turn address the individual TFT cells.

Working as an electro-optical switch, each TFT cell regulates transmitted light from the backlight assembly when worked by the data source. Color images are created by regulating the amount of transmitted light through the array of red, green and blue dots.

1.2 APPLICATIONS

• FA monitor

1.3 FEATURES

•Parallel 8bit interface (2 port)

•Ultra-wide viewing angle (with lateral electric field)

•Fast response time

•High luminance

•High contrast

•Wide color gamut

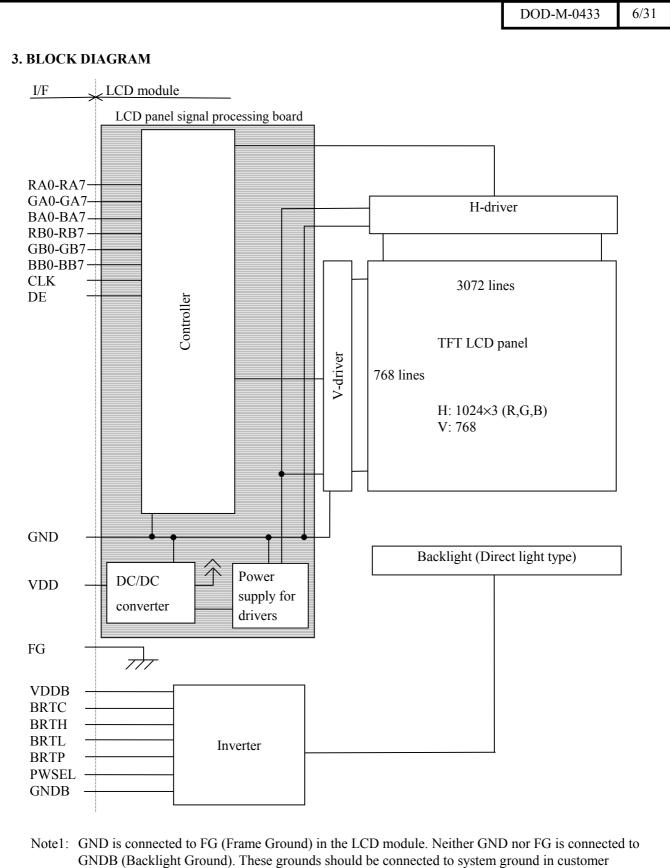
•Luminance control

•Small foot print

•Direct light type

•Replaceable backlight unit and inverter

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GENERAL SPECIFICATIONS		
Display area	304.128 (H) × 228.096 (V) mm	
Diagonal size of display	38 cm (15.0 inches)	
Drive system	a-Si TFT active matrix	
Display colors	16,777,216 colors (6bit + FRC)	
Number of pixels	1024 (H) × 768 (V) pixel	
Pixel arrangement	RGB (Red, Green, Blue) vertical stripe	
Dot pitch	$0.099 (H) \times 0.297 (V) mm$	
Pixel pitch	$0.297 (H) \times 0.297 (V) mm$	
Module size	330.0 (H) \times 256.0 (V) \times 30.0 Max.(D) mm	
Weight	1100 g (Typ.)	
Contrast ratio	300:1 (Typ.)	
<i>Viewing angle</i> (To be out of 10:1 for the contrast ratio)	 Horizontal: 85° (Typ., left side, right side) Vertical: 85° (Typ., up side, down side) 	
Designed viewing direction	• Optimum grayscale (γ=2.2): perpendicular	
Polarizer pencil-hardness	2H (Min., at JIS K5400)	
Color gamut	60 % (Typ.) At center, to NTSC	
Response time	Ton =10 ms (Typ.,10%→90%)	
Luminance	400 cd/m ² (Typ.)	
Signal system	Parallel 8bit interface (2port) [RGB 8bit data, CLK, DE]	
Supply voltage	5V (for LCD panel signal processing board) 12V (for Backlight inverter)	
Backlight	Direct light type: 8 cold cathode fluorescent lamps [Replaceable parts] • Backlight unit: TBD • Inverter: TBD	
Power consumption	24 W (Typ.) (Checkered flag pattern, at 400 cd/m ² Typ.)	



equipment.

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DETAILED S	PECIFICATIONS			_			
	CAL SPECIFICATIONS		Specification			Uı	nit
		$(H) \times 2^{4}$	$56.0 \pm 1.0 (V) \times 30.0$	Max (D)	Note1	m	-
	blay area		$= 0.5 (H) \times 228.096 \pm$		Note1	m	
	Veight		0 (Typ.), 1200 (Max.)			Ę	g
Note1: See	e "11.OUTLINE DRAWINGS) ".			I		
2 ABSOLUTE	MAXIMUM RATINGS						
	Parameters	Symbol	Rating	Unit	Ren	narks	
	LCD panel signal board	VDD	-0.3 to +6.0	V			
Supply voltage	Inverter	VDDB	-0.3 to +15.0	V	$Ta = 25^{\circ}C$		
	Display signals Note3	Vi	-0.3 to +3.8	V	$Ta = 25^{\circ}C$ $VDD=5.0V$ $Ta = 25^{\circ}C$ $VDDB=12V$		
	BRTC	ViB1	-0.3 to +5.5	V			
T (1)	BRTP	ViB2	-0.3 to +5.5	V			
Input voltage	PWSEL	ViB3	-0.3 to +5.5	V			
	ACA	ViB4	-0.3 to +5.5	V			
	BRTL	ViB5	-0.3 to +1.5	V			
	Storage temperature	Tst	-20 to +60			-	
	On another a formation of the	Top1	0 to +55	°C	Module front s	urface	Note1
	Operating temperature	Top2	TBD		Module rear su	rface	Note2
			≤ 95		Ta≤	40°C	
	Relative humidity (RH) Note4		≤ 85	%	40°C <ta≤ 50°c<="" td=""><td>С</td></ta≤>		С
			≤ 70		50°C <7	[a≤ 55°	С
	Absolute humidity Note4		≤ 78 Note5	g/m ³	Ta>	55°C	
	Operating altitude		≤ 4,850	m	0°C ≤ T	a ≤ 55°	С
	Storage altitude		≤ 13,600	m	-20°C ≤ 7	Гa ≤ 60	°C

Note1: Measure at the display area

Note2: Measure at the rear shield

Note3: Display signals are DE, CLK, RA0 to RB7, GA0 to GB7, BA0 to BB7

Note4: No condensation

Note5: Ta = 55°C, RH = 70%

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4.3 ELECTRICAL CHARACTERISTICS

4.3.1 Driving for LCD panel signal processing board

	1	6 1	e				$(Ta = 25^{\circ}C)$
Parameter		Symbol	Min.	Тур.	Max.	Unit	Remarks
Supply voltage		VDD	4.5	5.0	5.5	V	-
Supply current		IDD	-	300 Note1	600 Note2	mA	VDD=5.0V
Ripple voltage		VRP	-	-	100	mV	VDD=5.0V
Logic input voltage	Low	VTL	0	-	0.8	V	
Logic input voltage	High	VTH	2.0	-	3.6	V	-

Note1: Checker flag pattern (in EIAJ ED-2522) Note2: Theoretical maximum current pattern

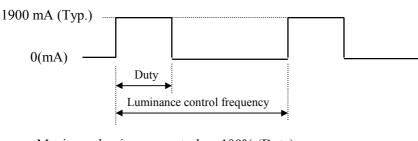
4.3.2 Driving for backlight inverter

							$(Ta = 25^{\circ}C)$
Parameter		Symbol	Min.	Тур.	Max.	Unit	Remarks
Supply voltage		VDDB	11.4	12.0	12.6	V	Backlight power supply
Supply current	Note1	IDDB	-	1900	2100	mA	VDDB=12.0V (at Max. luminance)
	BRTC	ViBL1	0	-	0.8	V	
	DKIC	ViBH1	2.0	-	5.0	V	-
	BRTP	ViBL2	0	-	0.8	V	
T a si a immed avalta sa	DKIP	ViBH2	2.0	-	5.0	V	-
Logic input voltage	PWSEL	ViBL3	0	-	0.8	V	
		ViBH3	2.0	-	5.0	V	-
	ACA	ViBL4	0	-	0.8	V	
		ViBH4	2.0	-	5.0	V	-
	BRTC	IiBL1	-610	-	-	μΑ	
		IiBH1	-	-	440	μΑ	-
	DDTD	IiBL2	-1580	-	-	μΑ	
To air innut summer	BRTP	IiBH2	-	-	3500	μΑ	-
Logic input current	DWOLL	IiBL3	-610	-	-	μΑ	
	PWSEL	IiBH3	-	-	440	μΑ	-
		IiBL4	-810	-	-	μΑ	
	ACA	IiBH4	-	-	440	μΑ	-
BRTL input current	BRTL	IiB5	-130	-	-	μΑ	-

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Note1: Inverter current wave is as follows.



Maximum luminance control : 100% (Duty) Minimum luminance control : 20% (Duty) Luminance control frequency : 285±14 Hz (Typ.)

Luminance control frequency indicate the input pulse frequency, when select the luminance control with external pulse. See "4.6.2 Luminance control with external pulse ".

4.3.3 Supply voltage ripple

This module works, even if the ripple levels are beyond the below values (See following the table.), but might have noise on the display image. Consider and evaluate enough before installing this module into customer's system.

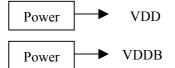
Supply voltage (Acceptable level)	Ripple voltage Note1 (Measure at input terminal of power supply)	Unit
VDD (for LCD panel signal processing board; 5.0V)	≤ 100	mVp-p
VDDB (for backlight inverter; 12V)	≤ 200	mVp-p

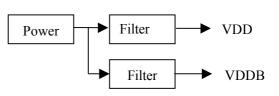
b) Put in the filters

Note1: The acceptable ripple voltage level includes spike noise.

Example of the power supply connections

a) Separate the power supply





4.3.4 Fuses

This module has fuses listed below. Check and evaluate power supplies of customer's system.

Fuse		Rating	Unit	Remarks
Туре	Supplier	Note1	Uliit	Remarks
FCC16202AB	KAMAYA ELECTRIC Co., Ltd.	2	А	VDD (for LCD panel signal processing board)
KE40	Daito Communication Apparatus Co,. Ltd	4	А	VDDB (for backlight inverter)

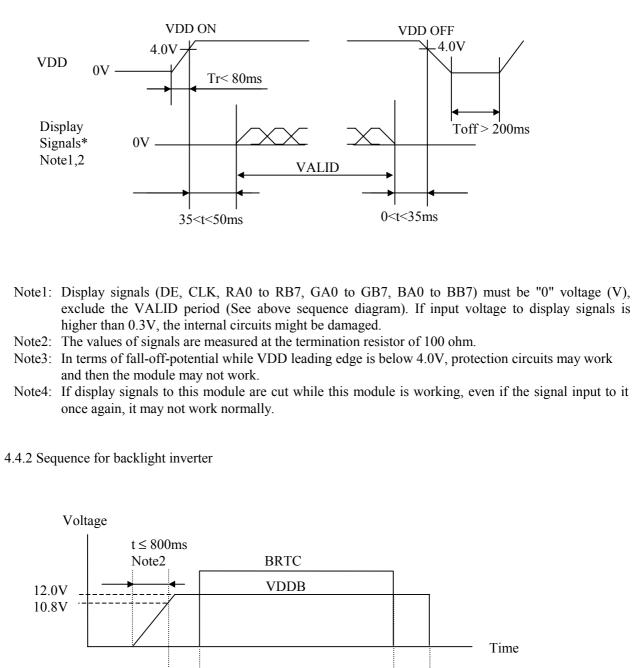
Note1: The power capacity should be more than 2 times of fuse ratings from safety point of view. If the power capacity of customer system is less than above request, check and evaluate it carefully.

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4.4 SUPPLY VOLTAGE SEQUENCE

4.4.1 Sequence for LCD panel signal processing board



0 ms < t 0 ms < t Note1: Backlight ON/OFF should be controlled, while display signals are supplied. The backlight power supply (VDDB) is not related to the power supply sequence. However, unstable data may be displayed when the backlight power is turned ON/OFF during display signals out.

Note2: Only when BRTC is Open.

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4.5 CONNECTIONS AND FUNCTIONS FOR INTERFACE PINS

4.5.1 LCD panel signal processing board

CN1 socket (Module side): IL-FHR-F45S-HF (JAE) or FH12S-45S-0.5SH (HIROSE)

Pin No.	Symbol	Function	Description		
1	GND	Ground	Connect to system ground.		
2	CLK	Dot clock	Dot clock input		
3	GND	Ground	Connect to system ground.		
4	DE	Data enable	Data enable input		
5	GND	Ground	Connect to system ground.		
6	N.C.	Non-connection	Keep the terminal open		
7	GND	Ground	Connect to system ground.		
8	N.C.	Non-connection	Keep the terminal open		
9	GND	Ground	Connect to system ground.		
10	N.C.	Non-connection	Keep the terminal open		
11	GND	Ground	Connect to system ground.		
12	BA7				
13	BA6	Odd minel data D	Odd pixel data B input		
14	BA5	Odd pixel data B	BA7: Most significant bit		
15	BA4				
16	GND	Ground	Connect to system ground.		
17	BA3				
18	BA2	Odd pixel data B	Odd pixel data B input		
19	BA1	Odd pixel data B	BA0: Least significant bit		
20	BA0				
21	GND	Ground	Connect to system ground.		
22	GA7				
23	GA6	Odd pixel data G	Odd pixel data G input		
24	GA5		GA7: Most significant bit		
25	GA4				
26	GND	Ground	Connect to system ground.		
27	GA3	_			
28	GA2	Odd pixel data G	Odd pixel data G input		
29	GA1		GA0: Least significant bit		
30	GA0				
31	GND	Ground	Connect to system ground.		
32	RA7	4			
33	RA6	Odd pixel data R	Odd pixel data R input		
34	RA5	r	RA7: Most significant bit		
35	RA4				
36	GND	Ground	Connect to system ground.		
37	RA3	4			
38	RA2	Odd pixel data R	Odd pixel data R input		
39	RA1	4	RA0: Least significant bit		
40	RA0				
41 42	VDD	4			
	VDD	Power Supply	+5V <u>+</u> 10%		
43 44	VDD	4			
44	VDD N.C.	Non connection	Veen the terminal open		
45 Note1		Non-connection	Keep the terminal open		

Note1: Do not keep pins free (except N.C. Pin) to avoid noise issue.

CN1 socket: Figure of socket

1 2

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Pin No.	Symbol	Function	Description					
1	GND	Ground	Connect to system ground.					
2	BB7							
3	BB6	Even pixel data B	Even pixel data B input					
4	BB5	Even pixel data B	BB7: Most significant bit					
5	BB4							
6	GND	Ground	Connect to system ground.					
7	BB3							
8	BB2	Even pixel data B	Even pixel data B input					
9	BB1	Even pixel data B	BB0: Least significant bit					
10	BB0							
11	GND	Ground	Connect to system ground.					
12	GB7							
13	GB6	Even pixel data G	Even pixel data G input					
14	GB5		GB7: Most significant bit					
15	GB4							
16	GND	Ground	Connect to system ground.					
17	GB3							
18	GB2	Even pixel data G	Even pixel data G input					
19	GB1	Even pixel data G	GB0: Least significant bit					
20	GB0							
21	GND	Ground	Connect to system ground.					
22	RB7							
23	RB6	Even pixel data R	Even pixel data R input					
24	RB5		RB7: Most significant bit					
25	RB4							
26	GND	Ground	Connect to system ground.					
27	RB3							
28	RB2	Even pixel data R	Even pixel data R input					
29	RB1		RB0: Least significant bit					
30	RB0							

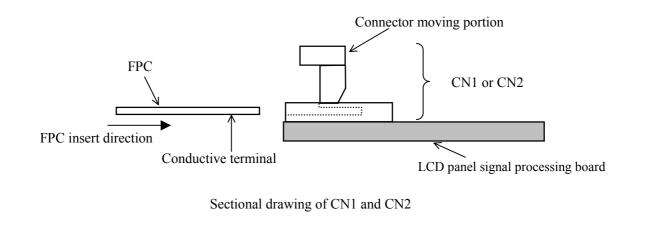
CN2 socket (Module side): IL-FHR-F30S-HF (JAE) or FH12S-30S-0.5SH (HIROSE)

Note1: Do not keep pins free to avoid noise issue.

CN2 socket: Figure of socket

2 29 30 1

Note2: Insert the FPC into the CN1 and CN2 with conductive terminal down.



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4.5.2 Backlight inverter

CN201 socket (Module side): DF3-8P-2H (HIROSE ELECRIC Co., Ltd.)

А	daptable	plug:	TBD								
	Pin No.	Symbol	Function	Description							
	1	GNDB									
	2	GNDB		Comment to contain amound							
	3	GNDB	Ground for backlight	Connect to system ground.							
	4	GNDB									
	5	VDDB									
	6	VDDB	Derver worder for head-light	+12V±5%							
	7	VDDB	Power supply for backlight	$+12 \text{ V} \pm 3 / 0$							
	8	VDDB									

Note1: Do not keep pins free to avoid noise issue.

CN201 socket: Figure of socket

1 2 7 8

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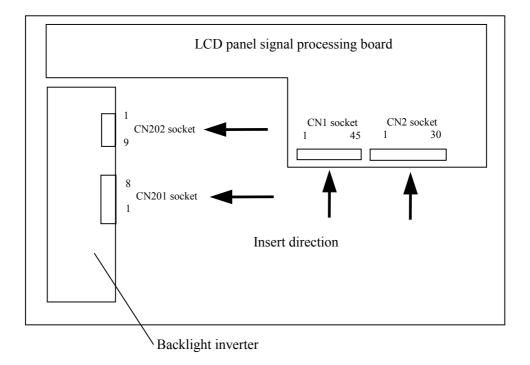
CN202 socket (Module side): IL-Z-9PL1-SMTY(JAE) Adaptable plug: TBD

Pin No.	Symbol	Function	Description					
1	GNDB	Crown d fan haaldisht	Comment to materia around					
2	GNDB	Ground for backlight	Connect to system ground.					
3	ACA	Luminance control signal	"High" or "Open" : Normal luminance 100% "Low" : Low luminance (TBD%)					
4	BRTC	Backlight ON/OFF control signal	"High" or "Open" : Backlight ON "Low" : Backlight OFF					
5	BRTH							
6	BRTL	Luminance control signal	See "4.6 LUMINANCE CONTROLS".					
7	BRTP							
8	GNDB	Ground for backlight	Connect to system ground.					
9	PWSEL	Luminance control select signal	See "4.6 LUMINANCE CONTROLS".					

CN202 socket: Figure from socket view



4.5.3 Position of sockets



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4.6 LUMINANCE CONTROLS

4.6.1 Luminance control method

Control method	Function and adjustment	PWSEL	BRTP
PWM	Luminance controlled by BRTP signal. See " 4.6.2 Luminance control with external luminance ".	Low	Input
Variable resistor Note1	The variable resistor for luminance control should be $10k\Omega$ type, and zero point of the resistor corresponds to the minimum of luminance. BRTH R Max. luminance (TBD%): R=10kΩ Min. luminance (TBD%): R=0Ω Mating variable resistor: $10k\Omega \pm 5\%$, B curve, 1/10W	High or Open	Open
Voltage Note1	BRTH should be fixed to 0V, and input to BRTL as follows. Max. Luminance (TBD%): 1V(Typ.) Min. Luminance (TBD%): 0V		

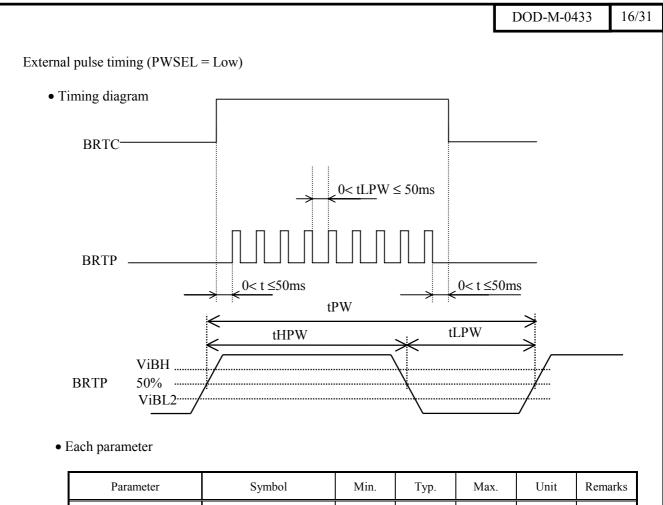
Note1: Luminance control may be overlap noises on the display image depending on input signal timing. In this case, keep off the interference between input signal and backlight driving signal, by PWM (Pulse Width Modulation) method.

4.6.2 Luminance control with external pulse

Luminance control with external pulse activated when PWSEL is Low and external pulse signal is inputted to BRTP. This luminance control is controlled by duty ratio, and luminance is as follows. Duty ratio=100%: Max. luminance Duty ratio=30%: Min. luminance

In case of BRTC = High or Open, the inverter will stop working when BRTP terminal is fixed to Low in the condition of PWSEL = Low. In this case, backlight will not turn on, even if external pulse signal is inputted to BRTP again. This is not out of order. Inverter will start to work when power is supplied again.

The display image may be disturbed by luminance control with external pulse when set up frequency is interfered with internal signal frequency.



Parame	ter	Symbol	Min.	Тур.	Max.	Unit	Remarks	
Input pulse fr	requency	1/tPW	185	-	325	Hz	Note1	
Low period		tLPW	-	-	50	ms	ms Note2	
Duty ra	tio	tHPW/tPW	20	-	100	%	Note3	
Luminance	e ratio	-	-	30-100	-	%	-	
Input voltage	Low	ViBL2	0	-	0.8	V	-	
Input voltage	High	ViBH2	2.0	-	5.0	V	-	

Note1: See the following formula for luminance control frequency.

Luminance control frequency = Vsync frequency \times (n+0.25) [or (n + 0.75)] Note2: In case tLPW is out of 50ms, backlight will turn off by its protection circuits. Note3: Max. Luminance at 100%

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										Data s	igna	l (0: l	low l	evel,	1: H	igh le	evel)								
Displa	y color	RA7	RA6	RA5	RA4	RA3	RA2	RA1	RA0	GA7 GA6 GA5 GA4 GA3 GA2 GA1 GA0				BA7 BA6 BA5 BA4 BA3 BA2 BA1 BA0											
		RB7	RB6	RB5	RB4	RB3	RB2	RB1	RB0	GB7	GB6	GB5	GB4	GB3	GB2	GB1	GB0	BB7	BB6	BB5	BB4	BB3	BB2	BB1	BB0
	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Blue	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
	Red	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Basic	Magenta	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
color	Green	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	Cyan	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Yellow	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
		0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	dark	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Red	\uparrow					:								:								:			
grayscale	\downarrow					:								:								:			
	bright	1	1	1	1	1	1	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
		1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
		0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0
	dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0
Green	↑					:								:								:			
grayscale	\downarrow					:								:								:			
	bright	0	0	0	0	0	0	0	0	1	1	1	1	1	1	0	1	0	0	0	0	0	0	0	0
		0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0
	Green	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
		0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
	dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0
Blue	\uparrow					:								:								:			
grayscale	\downarrow					:								:								:			
	bright	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	0	1
		0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	0
	Blue	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1

4.7 DISPLAY COLORS TO INPUT DATA SIGNALS

Note1: Colors are developed in combination with 8-bit signals (256 steps in grayscale) of each primary red, green, and blue color. This process can result in up to 16,777,216 (256×256×256) colors.

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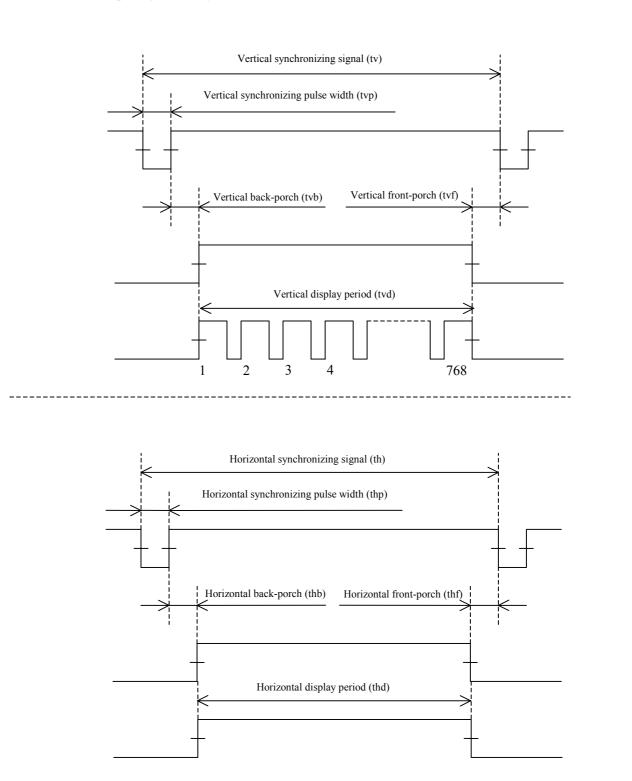
4.8 DISPLAY POSITIONS

Odd Pixel: RA= R DATA	Even Pixel : RB=R DATA
Odd Pixel: GA= G DATA	Even Pixel : GB=G DATA
Odd Pixel: BA= B DATA	Even Pixel : BB=B DATA

	D(1,1)) D(2,1)			
	RA GA E	BA RB GB	BB			
	1	1				
\langle	D(1,1)	D(2,1)		D(1024,1)		
	D(1,2)	D(2,2)	•••	D(1024,2)		
	٠	•	•	•		
	•	•	•	•		
	•	•	٠	•		
	•	•	•	•		
	•	•	•	•		
	D(1,768)	D(2,768)	•••	D(1024,768)		

4.9 INPUT SIGNAL TIMINGS

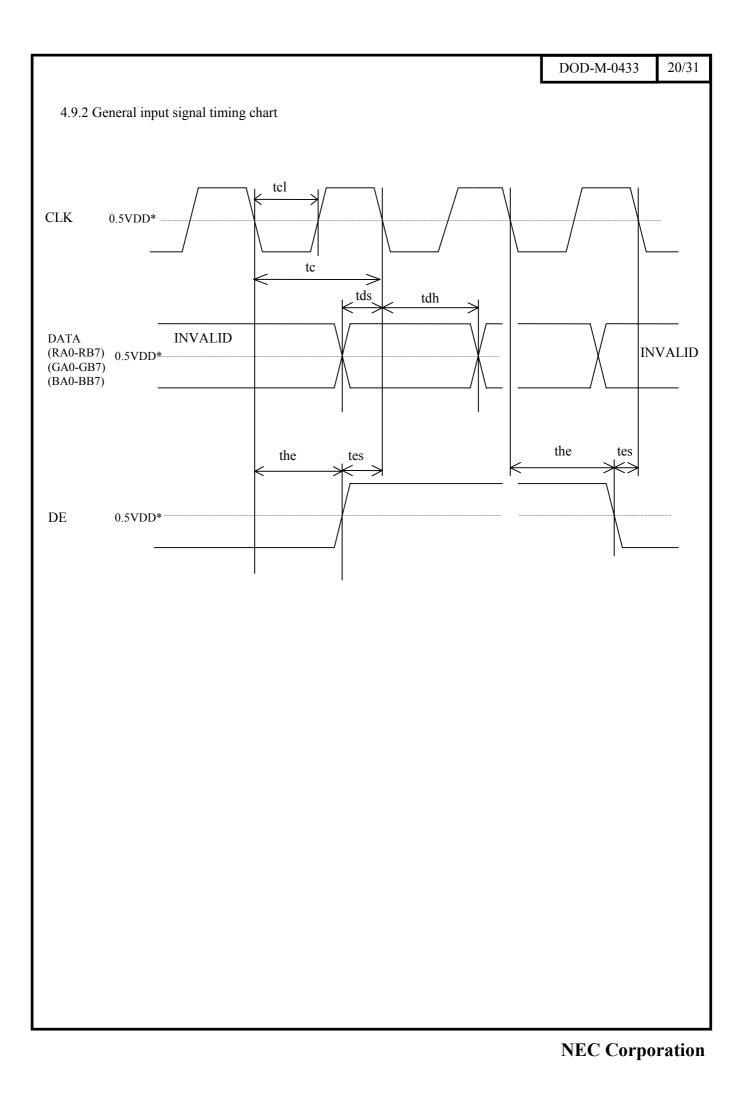
4.9.1 Definition of input signal timings

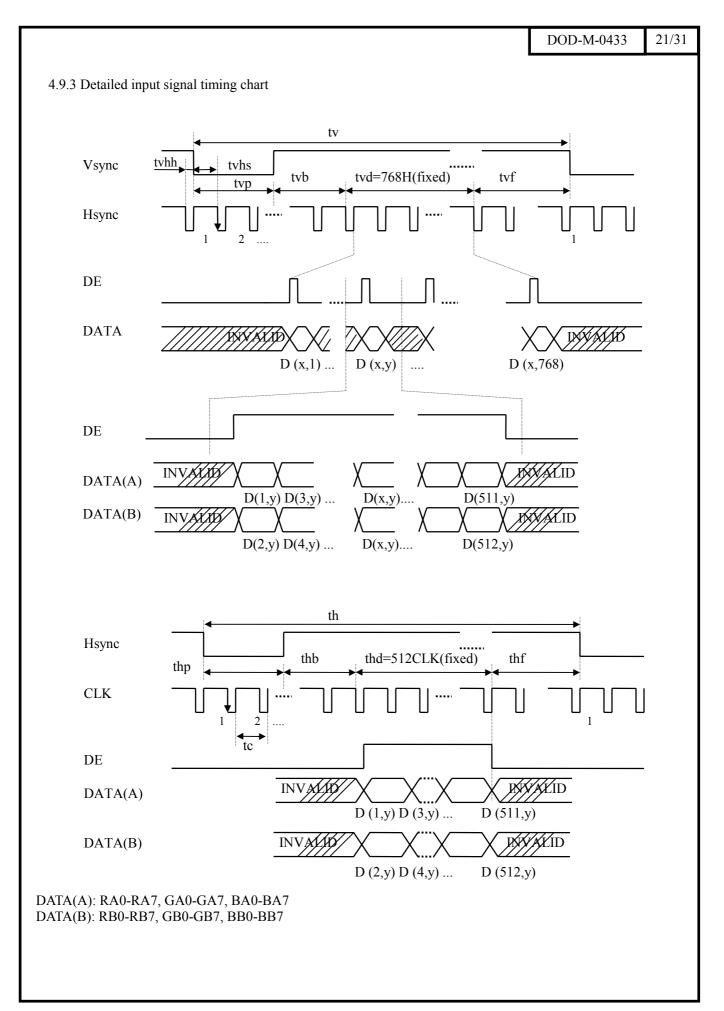


Note1: See "**4.9.4 Detailed input signal timing chart for numeration of pulse**". Note2: These diagrams indicate virtual signal for set up to timing.

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4.9.4 Timing characteristics (2 port input)

	Parameter	Symbol	Min.	Тур.	Max.	Unit	Remarks	
	Frequency	Vf=75Hz	-1/ tc	TBD -	39.375 25.397	TBD -	MHz ns	
CLK	Frequency	Vf=60Hz		TBD -	32.500 30.769	TBD -	MHz ns	
	Duty		tcl / tc	0.4	0.5	0.6	-	-
	Period	Vf=75Hz		(12.3) (550)	16.660 656	- (1000)	µs CLK	Typ.=60.023kHz
		Vf=60Hz		(12.3) (550)	20.677 672	- (1000)	µs CLK	Typ.=48.363kHz
	Display period		thd	-	512	-	CLK	-
Hsync	Front-porch	Vf=75Hz Vf=60Hz	—thf	-	8 12	-	CLK	-
	Pulse width	Pulse width Vf=75Hz Vf=60Hz		-	48 68	-	CLK	-
	Back-porch	Vf=75Hz Vf=60Hz	thb *	-	88 80	-	CLK	-
		* thp + thb	•	(38)	-	-	CLK	-
	Deried	Vf=75Hz		(771)	13.328 800	TBD -	ms H	Typ=75.029Hz
	Period	Vf=60Hz	tv	(771)	16.666 806	TBD -	ms H	Typ=60.0Hz
	Display period	•	tvd	-	768	-	Н	-
Vsync	Front-porch	Vf=75Hz Vf=60Hz	-tvf *	-	1 3	-	Н	-
	Pulse width		tvp *	-	3 6	-	Н	-
	Back-porch		tvb *	-	28 29	-	Н	-
		* tvp + tvb +		(3)	-	-	Н	-
	Vsync-Hsync tin		tvhs	1	-	-	CLK	-
	Hsync-Vsync tin	ning	tvhh	1	-	-	CLK	-
DATA (RA0-RB7)	DATA-CLK (Set	up)	tds	(2)	-	-	ns	-
(GA0-GB7) (BA0-BB7)	CLK-DATA (Ho	ld)	tdh	(2)	-	-	ns	-
DE	DE-CLK timing		tes	(2)	-	-	ns	-
DE	CLK-DE timing		the	(2)	-	-	ns	-

Note1: All parameters should be kept within the specified range. Also Definition of unit is as follows. 1CLK = tc

1H = th

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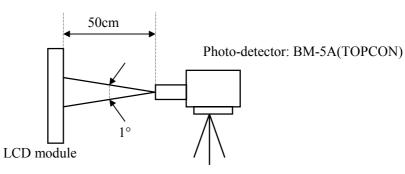
4.10 OPTICAL CHARACTERISTICS

			$Ta=25^{\circ}$	C, VDD= 5V, V	/DDB=	12V, N	ote1)	
Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit	Remarks	
Contrast ratio	CR	Note 3	(250)	300	-	-	Note2	4
Luminance	Lumax	Note 3	(300)	400	-	cd/m ²	-	4
Luminance uniformity	-	Max. / Min.	-	(1.1)	1.3	-	Note3,6	
	W	White (x, y)	-	(0.300, 0.315)	-	-		
Chromoticity accordinates	R	Red (x, y)	-	TBD	-	-	Note3	
Chromaticity coordinates	G	Green (x, y)	-	TBD	-	-	Notes	
	В	Blue (x, y)	-	TBD	-	-		

Reference data

(Ta=25°C, VDD=5V, VDDB=12V, Note1) Condition Parameter Symbol Min Typ Max. Unit Remarks С To NTSC Note3 50 % Color gamut 60 70 85 $\theta x +$ deg. Horizontal CR>10, $\theta y = \pm 0^{\circ}$ θx-70 85 deg. Viewing angle (CR>10) 70 θy+ 85 deg. Vertical CR>10, $\theta x = \pm 0^{\circ}$ 70 85 deg. θy--Note4 $\theta x +$ -85 deg. Horizontal CR>5, $\theta y = \pm 0^{\circ}$ Viewing angle θx-85 deg. --(CR>5) 85 $\theta v +$ _ deg. Vertical CR>5, $\theta x = \pm 0^{\circ}$ _ 85 _ deg. θy-Black to Response time Ton 10%→90% (10)(30)_ white (Module front surface Note3,5 ms White to temperature = $TBD^{\circ}C$) Toff 90%→10% (10)(20)black Luminance control range Maximum luminannce:100% 30-100 % _ _

Note1: Optical characteristics are measured after 20 minutes from the module works. The typical value is measured after luminance saturation. The luminance is measured in dark room. Input signal timing: XGA-60Hz mode



Note2: The contrast ratio is calculated by using the following formula.

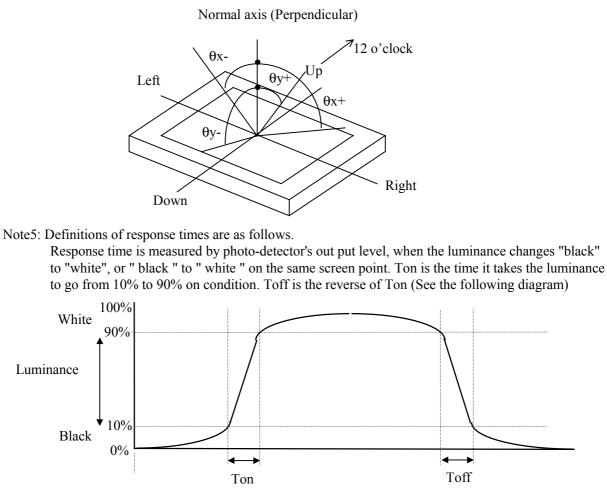
Contrast ratio (CR) = _____

Luminance with all pixels in black

Note3: Viewing angle is $\theta x = \pm 0^\circ$, $\theta y = \pm 0^\circ$ and at center.

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Note4: Definitions of viewing angles are as follows



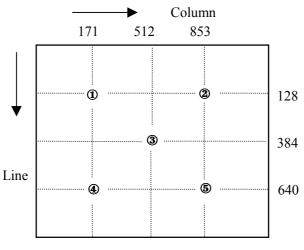
Note6: Luminance uniformity is calculated by using following formula.

Luminance uniformity =

Maximum luminance

Minimum luminance

The luminance is measured at near the five points shown below.



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5. RELIABILITY TEST

Test	item	Test condition	Judgment	
High temperature/	humidity operation	60±2°C, RH=60% 240 hours, Display data is white.	Note1	
Heat cycle (oper	ation)	 0°C ±3°C1 hour 55°C ±3°C1 hour 50 cycles , 4 hours/cycle Display data is white. 	Note1	
Thermal shock (non-ope	eration)	 -20°C ±3°C30 minutes 60°C ±3°C30 minutes 100 cycles Temperature transition time is within 5 minutes. 	Note1	
Vibration (non-op	eration)	 5-100Hz, 11.76m/s², 1 minute/cycle, X,Y,Z direction 10 times each direction 	Note1, Note2	
Mechanical shock (non-operation)		 294m/s², 11ms X,Y,Z direction 3 times each direction 	Note1, Note2	
ESD (operation)		150pF, 150Ω, ±10kV 9 places on a panel *3 10 times each place at one-second intervals	Note1	
Dust (operation)		15 kinds of dust (JIS-Z 8901) Hourly 15 seconds stir, 8 times repeat	Note1	
Low pressure	operation	53.3 kPa 0°C±3°C 24 hours 55°C±3°C 24 hours	Note 1	
	non-operation	15 kPa -20°C ±3°C 24 hours -60°C±3°C 24 hours		

Note1: No display malfunctions (Display functions are checked under the same conditions as out-going inspection.)

Note2: Physical damage

Note3: See the following figure for discharge points.

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6. PRECAUTIONS

6.1 MEANING OF CAUTION SIGNS

The following caution signs have very important meaning. Be sure to understand following contents, respectively.

CAUTION This sign has a meaning that customer will be injured himself and/or the module will sustain a damage, if he makes a mistake in operations.



This sign has a meaning that customer will get an electric shock if he makes a mistake in operations.



This sign has a meaning that customer will be injured himself if he makes a mistake in operations.

6.2 CAUTIONS

Do not touch HIGH VOLTAGE PART of the inverter while turn on. Customer will be in danger of an electric shock.

* Pay attention to handling for the working backlight. It may be over 35°C from ambient temperature.

* Do not shock and press the LCD panel and the backlight. There will be in danger of breaking, because they are made of glass. (Shock: To be not greater 294m/s² (30G) and to be not greater 11ms, Pressure: To be not greater 19.6N (2kgf))

6.3 ATTENTIONS

- (1) Handling the product
 - ① When customer pulls out products from carton box, take hold of both ends without touch the circuit board. If customer touches it, products may be broken down and/or out of adjustment, because of stress to mounting parts.
 - ^② If customer places products temporarily, turn down the display side and place on a flat table.
 - ③ Handle products with care and avoid electrostatic discharge (e.g. Decrease with earth band, ionic shower, etc.), because products (LCD modules) may be damaged by electrostatic.
 - ④ The torque for mounting screws should never exceed 0.39N⋅m. Over torque may cause mechanical damage to the product.
 - ⑤ Do not press or friction, because LCD panel surface is sensitive. If customer will clean the product surface, NEC Corporation or their supplier will recommend using the cloth with ethanolic liquid.

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- ⑥ Do not push-pull the interface connectors while turn on, because wrong power sequence may break down the product.
- ⑦ Connection cables such as flexible cable, and so on, are danger of damage. Do not hook cables nor pull them.

(2) Environment

- ① Dewdrop atmosphere must be avoided.
- ② Do not operate and/or stores in high temperature and/or high humidity atmosphere. If customer store the product, keep in antistatic pouch in room temperature, because of avoidance for dusts and sunlight.
- ③ Do not operate in high magnetic field. Circuit boards may be broken down by it.
- (1) Use an original protection sheet on product surface (polarizer). Adhesive type protection sheet should be avoided, because it may change color and/or properties of the polarizer.
- (3) Specification for products
 - ① Do not display the fixed pattern for a long time because it may cause image sticking. If the fixed pattern is displayed on the screen, use a screen saver.
 - ② The product may be changed of color by viewing angle because of the use of condenser sheet for backlight unit.
 - ③ The product may be changed of luminance by voltage variation, even if power source applies recommended voltage to backlight inverter.
 - ④ Optical characteristics may be changed by input signal timings.

(4) Other

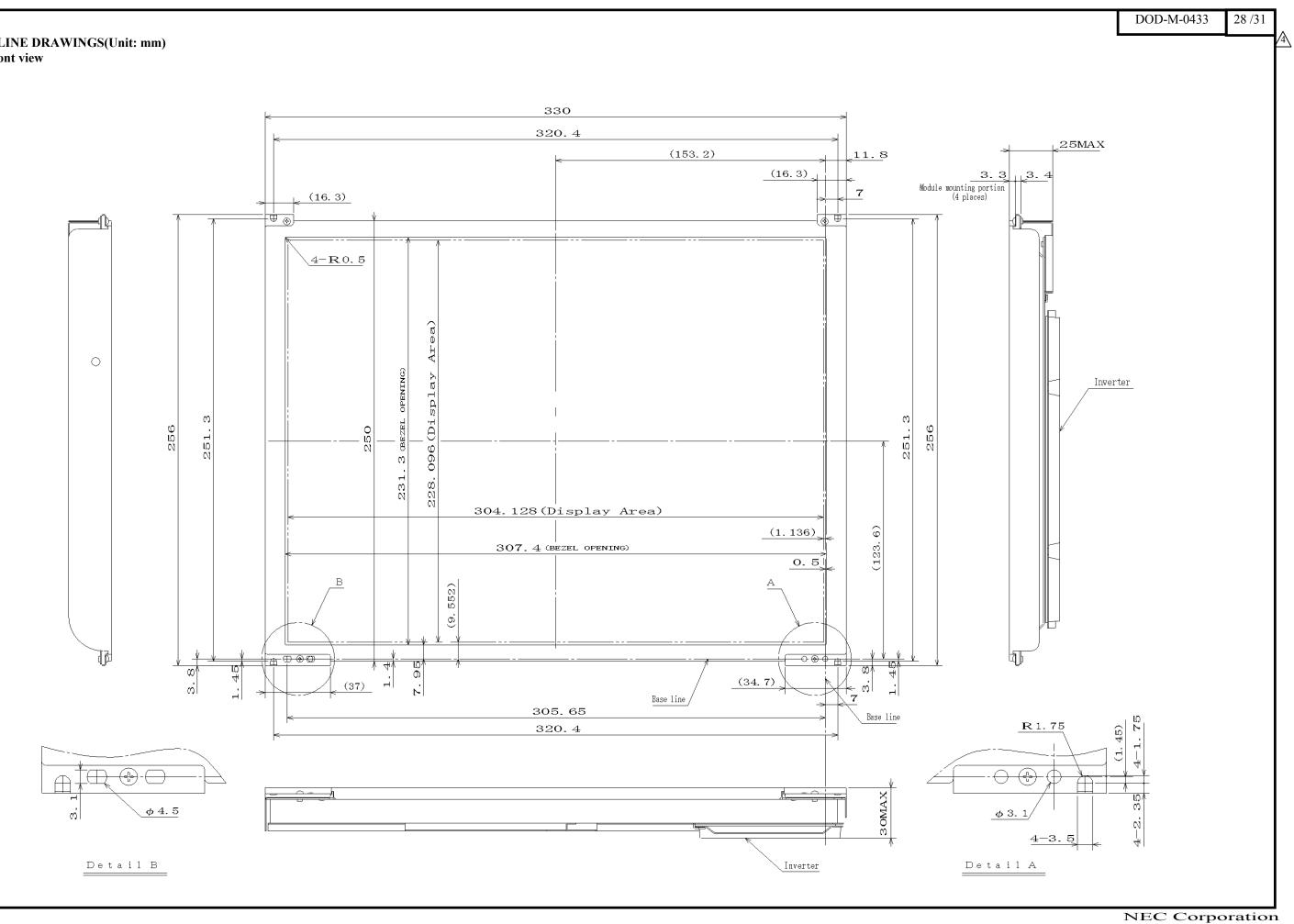
- ① All GND, GNDB, VDD and VDDB terminals should be connected without a non-connected signal line.
- ② Do not disassemble a product and/or adjust volume.
- ⁽³⁾ If customer would like to replace backlight lamps, see 'REPLACEMENT MANUAL FOR BACKLIGHT'.
- ④ If customer use screwnails, pay attention not to insert waste materials in inside of products.
- S When customer returns product for repair and so on, pack it with original shipping package because of avoidance of some damages during transportation.

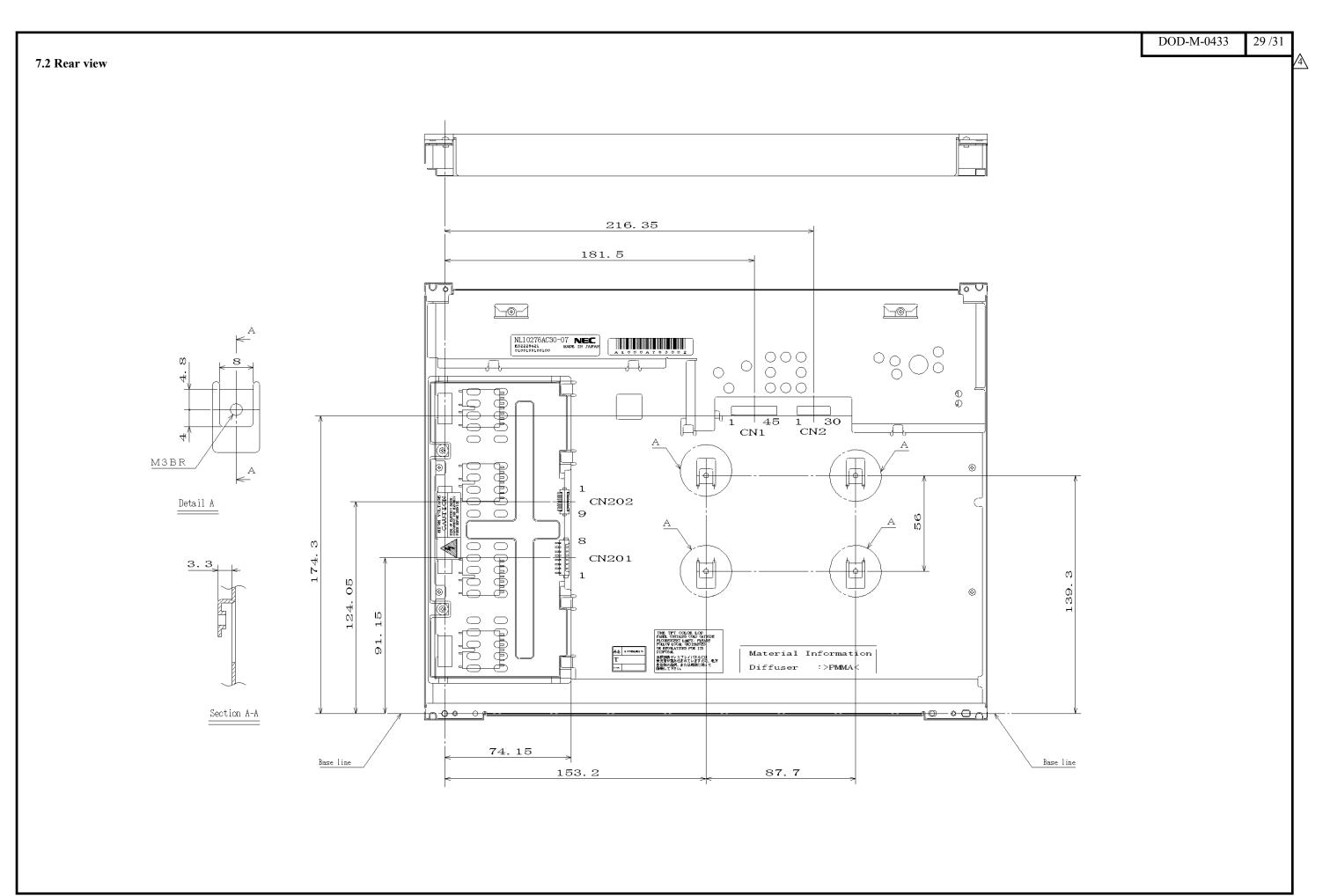
General specifications for the LCD

The following items are neither defects nor failures.

- * Response time, luminance and color gamut may be changed by ambient temperature.
- * The LCD may be seemed luminance uniformity, flicker, vertical seam and/or small spot by display patterns.
- * Optical characteristics (e.g. luminance, display uniformity, etc.) gradually is going to change depending on operating time, and especially low temperature, because the LCD has cold cathode fluorescent lamps.

7. OUTLINE DRAWINGS(Unit: mm) 7.1 Front view





		Revision History	D	OOD-M-0433	30/31
Rev.	prepared date	Revision contents		Signature of wr	riter
1st edition	Jan. 25, 2001	DOD-M-0094(abstract)		Approved by <u>A. OKAMC</u> Checked by <u>Prepared by</u> <u>R.KAWASI</u>	
2nd edition	Feb. 6, 2001	 DOD-M-0140(abstract) P5 Outline of characteristics: Expression of viewing angle is revised. P7,8 Symbols: VCC→VDD, ICC→ IDD (correction) P7 ABSOLUTE MAXIMUM RATINGS: VDD is corrected. P14 (4) Luminance control: Expression of remark is revised. P15 Symbols: Luminance→Luminance ratio (correction) P23 Vibration: 50 times→10 times (collection) ESTIMATED LIFE TIME OF THE BARE LAMP is delete 	d.	Approved by _A. OKAMO Checked by Prepared by R.KAWASH	
3rd edition	Mar. 30, 2001	 DOD-M-0276 Change part (Before-2nd edition → After-3rd edition) The inside of this document is revised the clerical error and unclear expression in previous one. The important changes such as specifications, characteristics an functions are as follows. P5,P7,P28 Module size (Vertical): 255.4mm→256.0mm P6 BLOCK DIAGRAM-Vertical resolution: 1024→768 P7 ABSOLUTE MAXIMUM RATINGS VDDB: -0.3 to +16.0V → -0.3 to +15.0V ACA is added. Absolute humidity: Absolute humidity shall not exceed Ta=50°C, Relative humidity =70% level. → ≤ 78 g/m³ P8 Driving for backlight inverter Logic input voltage is added. ACA is added. P13 Backlight inverter- CN202 socket-Pin No.2: N.C. →ACA P18 Definition of input signal timings are added. P24 RELIABILITY TEST: Low pressure is added. P27,P28 OUTLINE DRAWINGS are revised. 	d	Approved by _A.OKAMOTO Checked by Prepared by R.KAWASHIMA	

Rev. prepared date Revision contents Signature of writer 4th edition June 12, 2001 DOD-M-0433 Approved by The import of this document is revised the clerical error and unclear expression in previous one. The important changes such as specifications, characteristics and functions are as follows. Approved by P4 Applications: PC monitor is deleted. P5, P7, Nodule weight: LOOg Typ., TBD Max. → 1100g Typ., 1200g Max. P5, P7, Module weight: LOOg Typ., TBD Max. → 1100g Typ., 1200g Max. P5, P23: Luminance is decided. P5 Block diagram: Notel is changed. P7 Absolute maximum ratings BRTP, PWSUL, ACA, BRTL, Operating altitude and Storage altitude: Each parameter is decided. P8 Electrical characteristics IIDD, BRTC, BRTP, PWSEL, ACA and BRTL: Each parameter is decided. P1 ON Sequence for LCD panel signal processing board is decided. P1 ON Sect: "FIL23-S05-0.5SH (HIROSE)" is added. Adaptable plug is deleted. Note: 2 is added P28, P29: Outline drawings are changed.
 4th edition June 12, 2001 DOD-M-0433 Change part (Before-3rd edition → After-4th edition) The inside of this document is revised the clerical error and unclear expression in previous one. The important changes such as specifications, characteristics and functions are as follows. P4 Applications: PC monitor is deleted. P5, P7, P28 Module thickness: 32.0mm Max. → 30mm Max. P5, P7 Module weight: 1200g Typ., TBD Max. → 1100g Typ., 1200g Max. P5, P23 Contrast ratio is decided. P6 Block diagram: Note1 is changed. P7 Absolute maximum ratings BRTP, PWSEL, ACA, BRTL, Operating altitude and Storage altitude: Each parameter is decided. P8 Electrical characteristics IDD, BRTC, BRTP, PWSEL, ACA and BRTL: Each parameter is decided. P9 Luminance control frequency is decided. P9 Sues are decided. P10 Sequence for LCD panel signal processing board is decided. P10 Sequence for LCD panel signal processing board is decided. P11 CN1 socket: "FH12S-45S-0.5SH (HIROSE)" is added. Adaptable plug is deleted. P12 CN2 socket: "FH12S-45S-0.5SH (HIROSE)" is added. Adaptable plug is deleted. P12 CN2 socket: "FH12S-45S-0.5SH (HIROSE)" is added. Adaptable plug is deleted. P12 CN2 socket: "FH12S-45S-0.5SH (HIROSE)" is added. Adaptable plug is deleted. P12 CN2 socket: "FH12S-45S-0.5SH (HIROSE)" is added. Adaptable plug is deleted. P12 CN2 socket: "FH12S-45S-0.5SH (HIROSE)" is added. Adaptable plug is deleted. P12 CN2 socket: "FH12S-45S-0.5SH (HIROSE)" is added. Adaptable plug is deleted. P12 CN2 socket: "FH12S-45S-0.5SH (HIROSE)" is added. Adaptable plug is deleted. P12 CN2 socket: "FH12S-45S-0.5SH (HIROSE)" is added. Adaptable plug is deleted. P12 CN2 socket: "FH12S-45S-0.5SH (HIROSE)" is added. P13 CN2 socket: "FH12